# KME-702:

# LCF and TMF Crack Growth in Cast Nickel-Based Superalloys

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## **Energy Context**

- Increasing renewable energy sources
- Intermittent
- Problem with energy storage







#### "One" solution = Gas turbines

- Gas turbines traditionally designed for base load operation.
- Operational flexibility increases with introduction of renewable energy.
  - Balancing the power grid
  - Fast start-up and shut-down times
  - Fuel flexibile
  - Cyclic load conditions, more starts and stops → fatigue



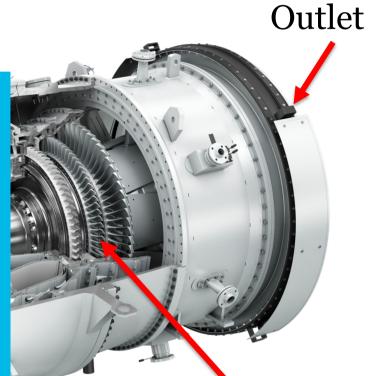






#### **Gas Turbines**

- Highest temperature in turbine section
- Cast nickel-base superalloys, IN792, SX
- Improved creep and oxidations properties
- Complex material behaviour



Turbine

section

Inlet

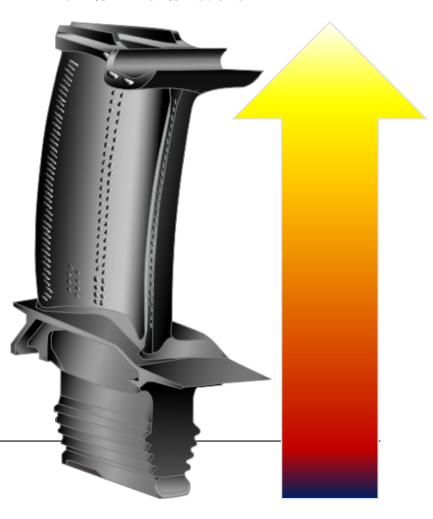


# **Turbine section**

### Turbine disc



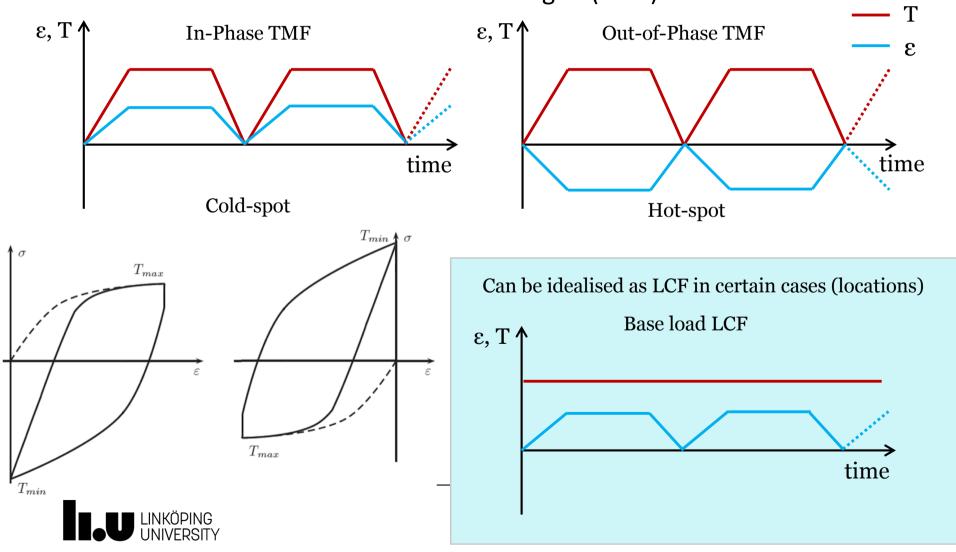
### Turbine blade





# Cyclic conditions





# Key objectives of KME-702

- Validate a TMF crack growth test method that can be used to generate high quality data for cast nickel-based superalloys, including single-crystals.
- 2. Generation of high quality test data for TMF crack growth in the corrosion resistant single-crystal superalloy STAL15.
- 3. Improve the knowledge regarding the mechanisms that controls the crack growth rate in single-crystal superalloys.
- 4. Develop TMF crack growth models and life prediction methodologies that will reduce the need for high safety margins.
- 5. Validate the models for component near conditions.

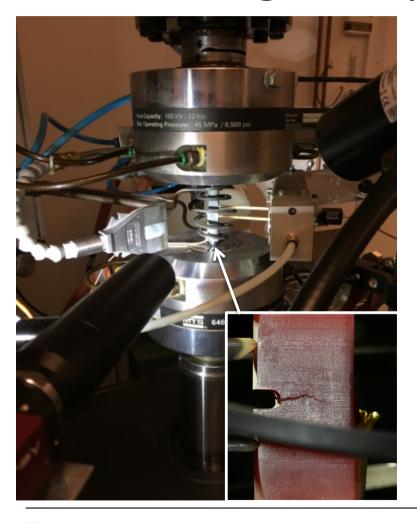
Efficient and robust gas turbines with high flexibility with respect to fuel and cyclic operation

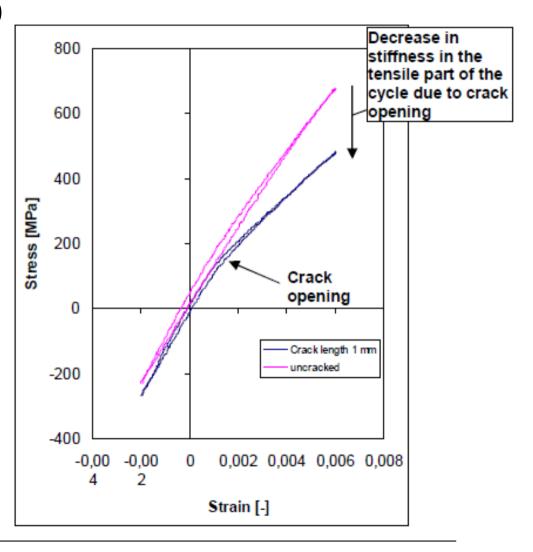
# Testing methods - Overview

	Kb	DCT	SEN-FSP	SEN-ORL
Isothermal	a			
TMF				



# TMF testing - setup

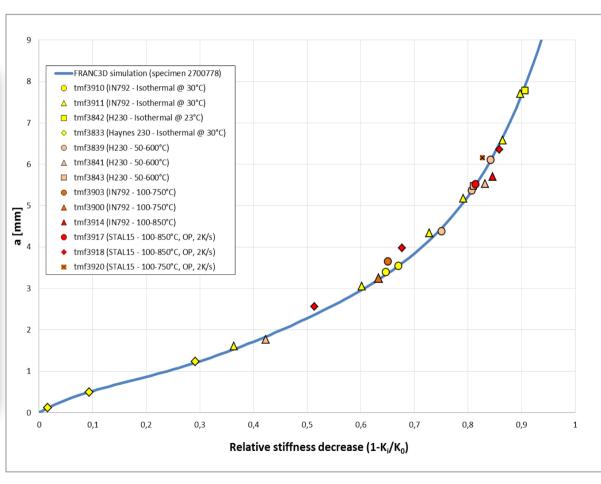




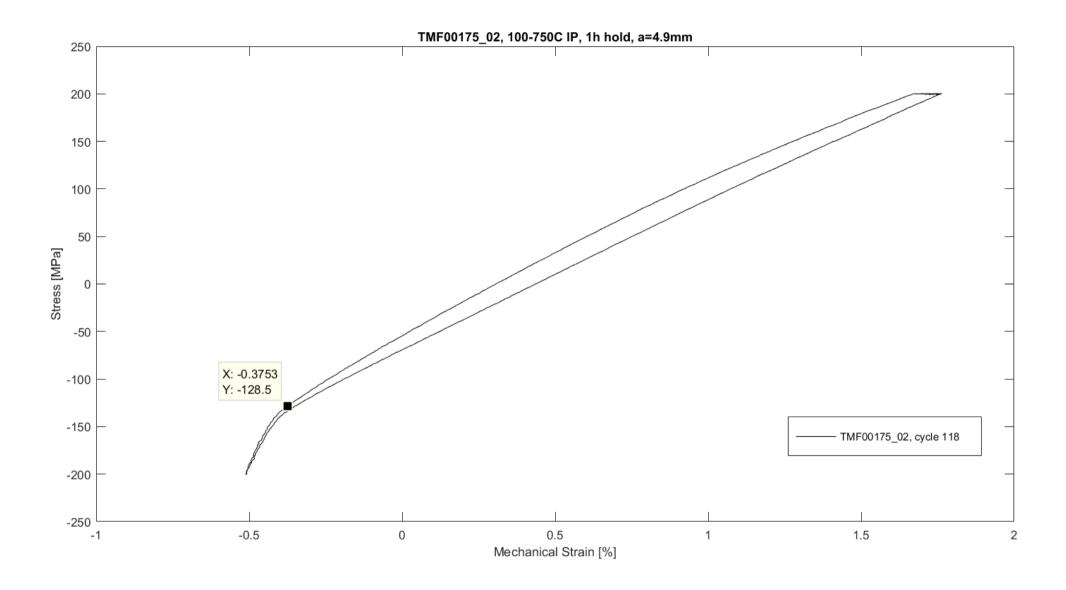


# TMF testing – crack length measurement





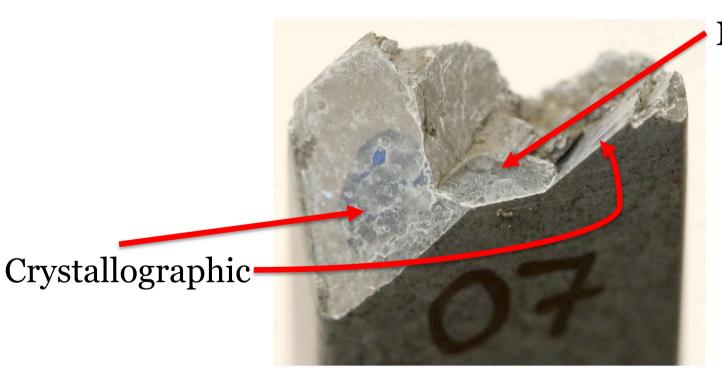






#### Fracture Behaviour

• Cracks tend to transition from Mode I cracking to crystallographic cracking



Mode I

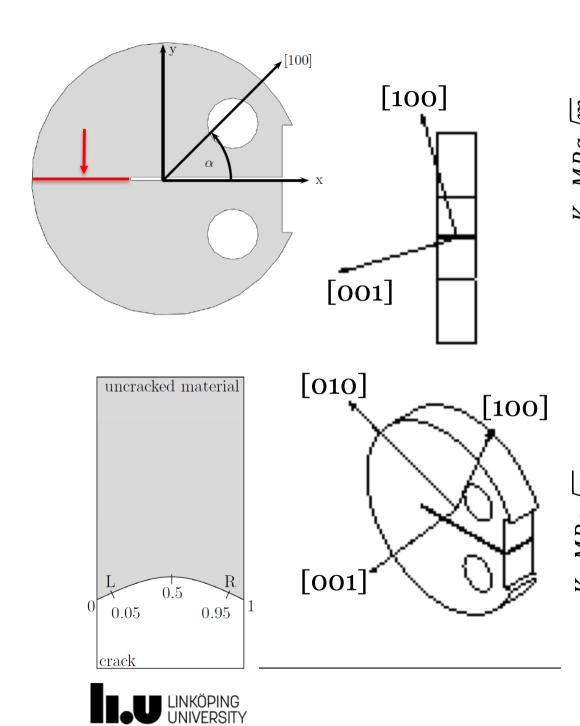
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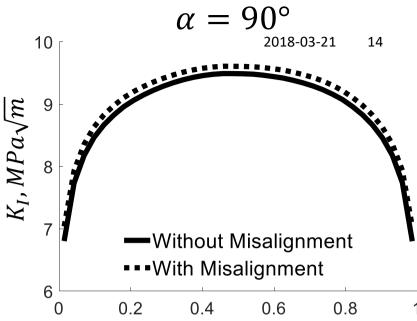


# Modelling

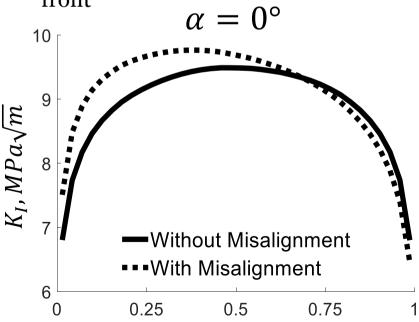
- Develop crack growth models and life prediction methodologies that will reduce the need for high safety margins
- Prediction of
  - When the cracking mode transition occurs
  - Which crystallographic plane it transitions to
  - How fast it grows on the crystallographic plane





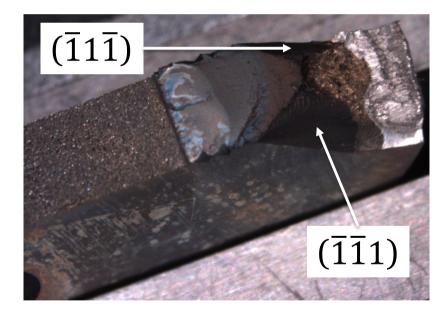


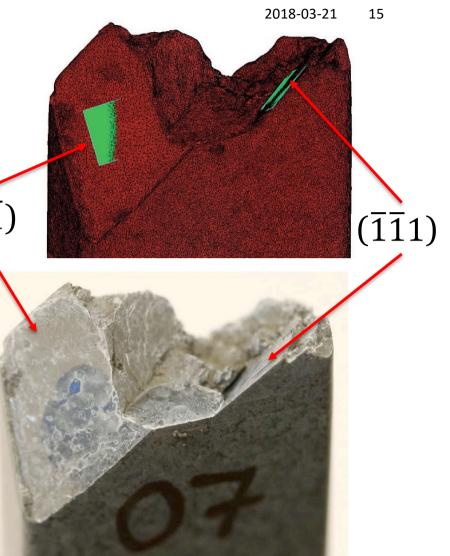
Normalized distance along the crack front



Normalized distance along the crack front

• Determination of crystallographic planes  $(\overline{1}1\overline{1})$ 





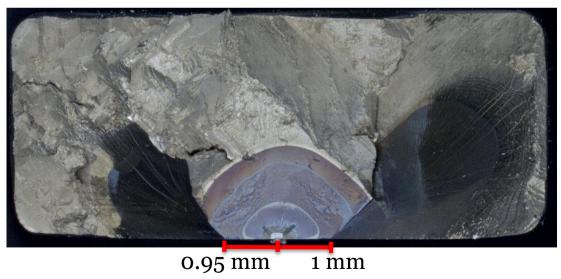


# Transition crack lengths

- Transition crack lengths measurements
- First global crystallographic plane









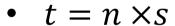
# **Resolved Stress Intensity Factors**

Resolved SIFs

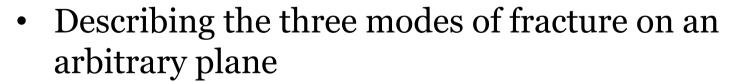
$$k_{II}(n,s) = \lim_{r \to 0} \sqrt{2\pi r} \, n \cdot \sigma(s) \cdot n$$
  

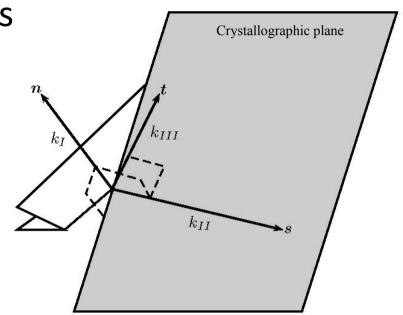
$$k_{II}(n,s) = \lim_{r \to 0} \sqrt{2\pi r} \, s \cdot \sigma(s) \cdot n$$
  

$$k_{III}(n,s) = \lim_{r \to 0} \sqrt{2\pi r} \, t \cdot \sigma(s) \cdot n$$











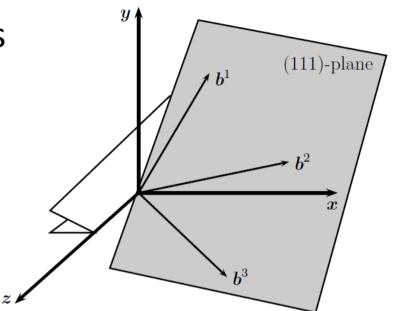
# **Resolved Stress Intensity Factors**

Resolved SIFs

$$k_{II}(n,s) = \lim_{r \to 0} \sqrt{2\pi r} \, n \cdot \sigma(s) \cdot n$$

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- Evaluation direction  $\boldsymbol{s}$  to be in Burgers' directions  $\boldsymbol{b}$ 
  - Physically inspired by micromechanisms
  - Directions of least resistance to dislocation motion



## **Resolved Stress Intensity Factors**

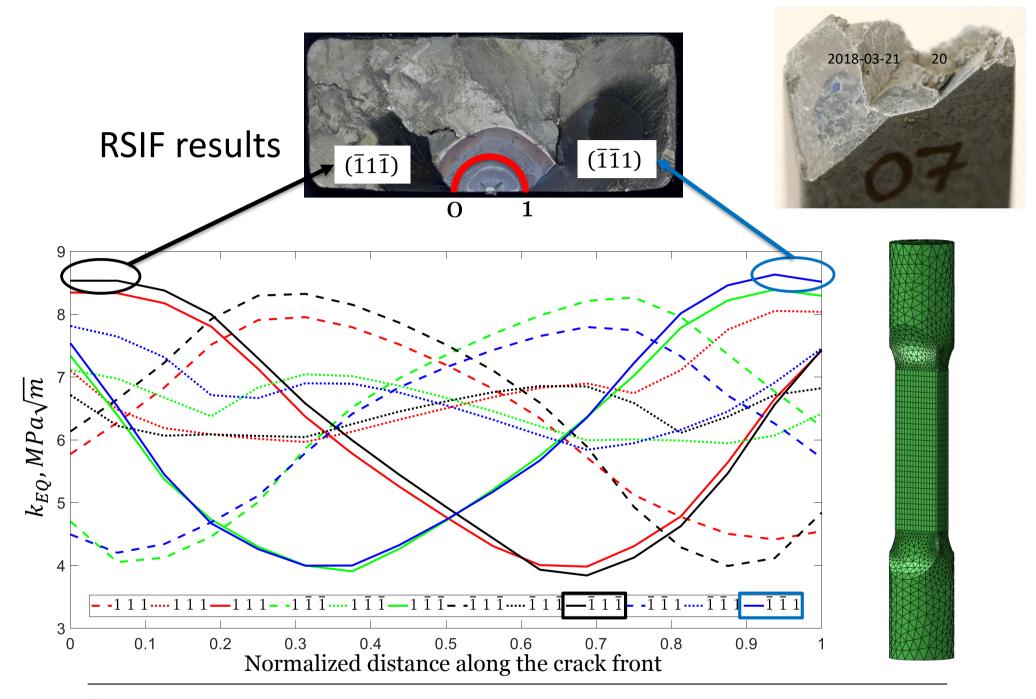
Equivalent RSIF

$$k_{EQ} = \sqrt{\psi k_I^2 + k_{II}^2 + k_{III}^2}$$

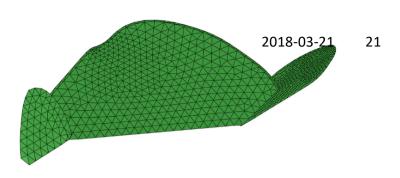
where  $\psi$  is a calibration parameters based on the experiments

- Resolved shear stresses weaken the crystallographic planes by dislocation motion
- Resolved normal stresses facilitate dislocation motion







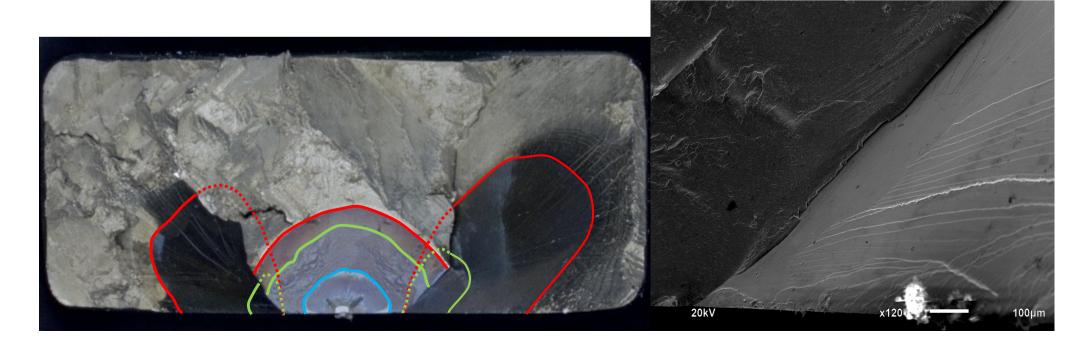


# Crack propagation rate

Evaluation of crystallographic crack growth rate

$$\frac{\mathrm{d}L}{\mathrm{d}N} = C_c (k_{EQ})^{n_c},$$

- RSIF used in crack growth model as proposed by Paris
- 3D crack geometry with three crack fronts



# **Conclusions**

- A good prediction of the experiments was accomplished with the developed RSIF.
- The crystal orientation has a strong influence on the stress response and propensity for crystallographic cracking.
- The method to evaluate the TMF crack growth has been verified for different test conditions.
- The crack closure has a high impact on the crack growth rate at higher temperatures.



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